

N-Channel Enhancement Mode Power MOSFET

Description

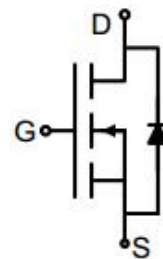
The GT025N06F uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.

General Features

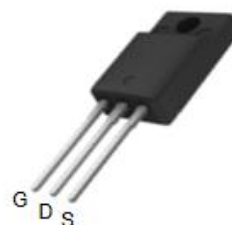
- V_{DS} 60V
- I_D (at $V_{GS} = 10V$) 120A
- $R_{DS(ON)}$ (at $V_{GS} = 10V$) < 3m Ω
- $R_{DS(ON)}$ (at $V_{GS} = 4.5V$) < 3.6m Ω
- 100% Avalanche Tested
- RoHS Compliant

Application

- Power switch
- DC/DC converters
- Synchronous Rectification



Schematic Diagram



TO-220F

Device	Package	Marking	Packaging
GT025N06F	TO-220F	GT025N06	50pcs/Tube

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	60	V
Continuous Drain Current	$T_C = 25^\circ\text{C}$	120	A
	$T_C = 100^\circ\text{C}$	76	
Pulsed Drain Current (note1)	I_{DM}	480	A
Gate-Source Voltage	V_{GS}	± 20	V
Power Dissipation	P_D	55	W
Single pulse avalanche energy (note2)	E_{AS}	420	mJ
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	$^\circ\text{C}$

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	50	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Case	R_{thJC}	2.3	$^\circ\text{C/W}$

Specifications T _J = 25°C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	60	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60V, V _{GS} = 0V	--	--	1	μA
Gate-Source Leakage	I _{GSS}	V _{GS} = ±20V	--	--	±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.2	1.9	2.5	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 50A	--	2.5	3.0	mΩ
		V _{GS} = 4.5V, I _D = 25A	--	3.0	3.6	
Forward Transconductance	g _{FS}	V _{DS} = 5V,I _D = 50A	--	60	--	S
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 30V, f = 0.8MHz	--	5300	--	pF
Output Capacitance	C _{oss}		--	1400	--	
Reverse Transfer Capacitance	C _{rss}		--	70	--	
Total Gate Charge	Q _g	V _{DD} = 30V, I _D = 50A, V _{GS} = 10V	--	70	--	nC
Gate-Source Charge	Q _{gs}		--	21	--	
Gate-Drain Charge	Q _{gd}		--	16	--	
Turn-on Delay Time	t _{d(on)}	V _{DD} = 30V, I _D = 50A, R _G = 3Ω	--	16	--	ns
Turn-on Rise Time	t _r		--	9	--	
Turn-off Delay Time	t _{d(off)}		--	36	--	
Turn-off Fall Time	t _f		--	11	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I _S	T _C = 25°C	--	--	120	A
Body Diode Voltage	V _{SD}	T _J = 25°C, I _{SD} = 50A, V _{GS} = 0V	--	--	1.2	V
Reverse Recovery Chrage	Qrr	I _F = 50A, V _{GS} = 0V di/dt=500A/us		150	--	nC
Reverse Recovery Time	Trr			30	--	ns

Notes

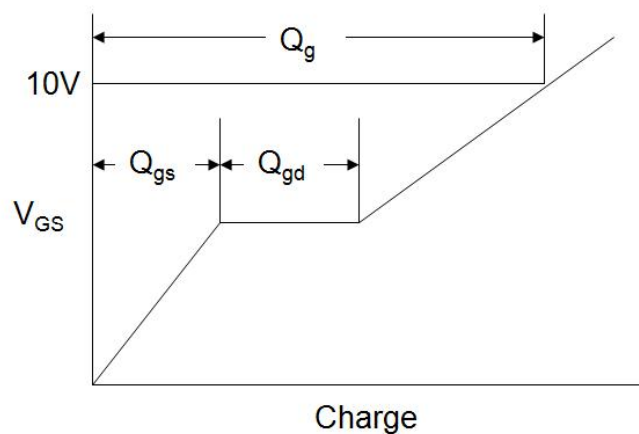
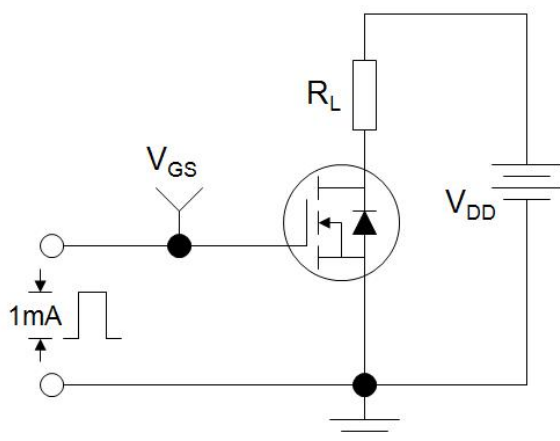
1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. EAS condition : $T_J=25^{\circ}\text{C}$, $V_{DD}=50V, V_{GS}=10V, L=0.5mH, R_g=25\Omega$

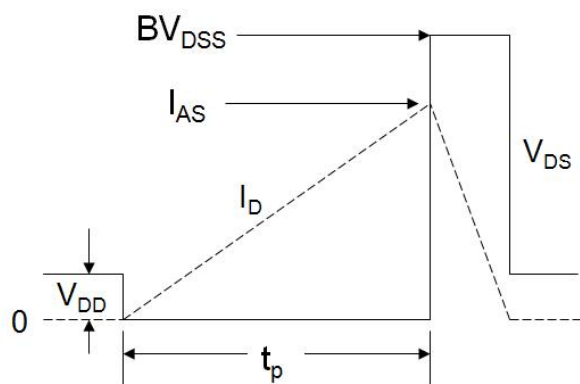
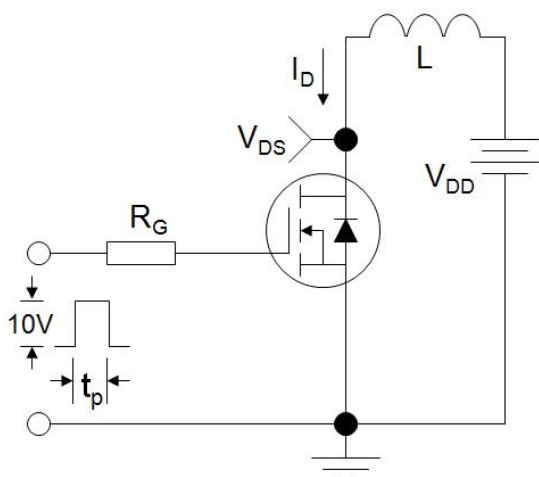
The table shows the minimum avalanche energy, which is 1156mJ when the device is tested until failure

3. Identical low side and high side switch with identical R_G

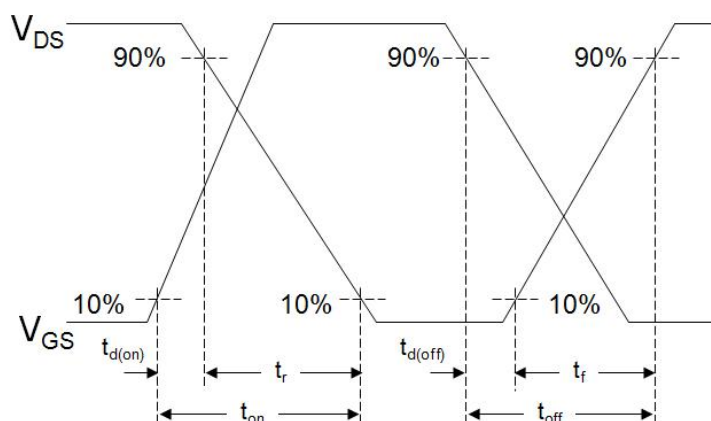
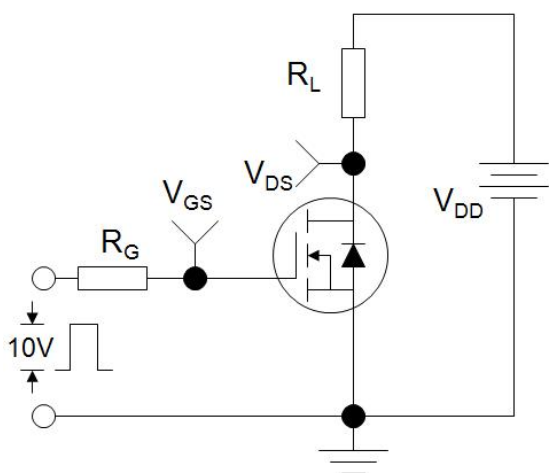
Gate Charge Test Circuit



EAS Test Circuit



Switch Time Test Circuit



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

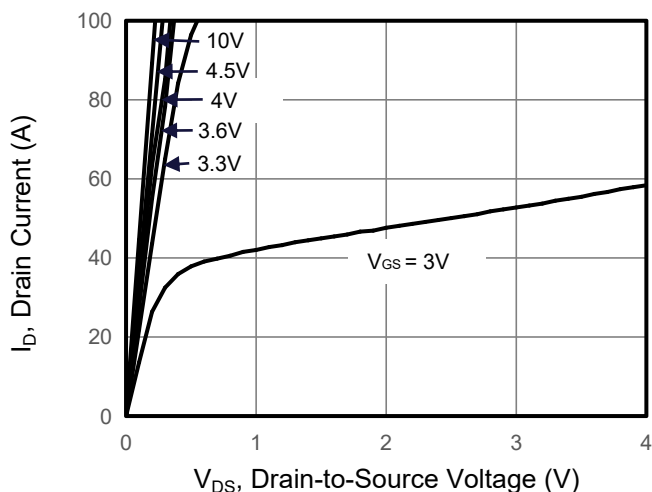


Figure 2. Transfer Characteristics

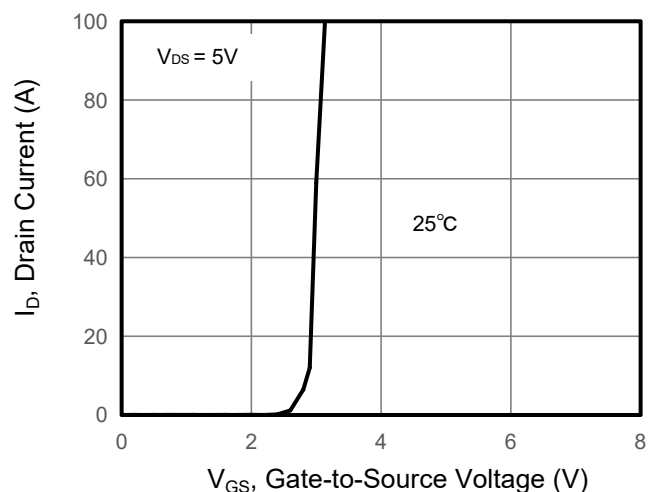


Figure 3. Drain Source On Resistance

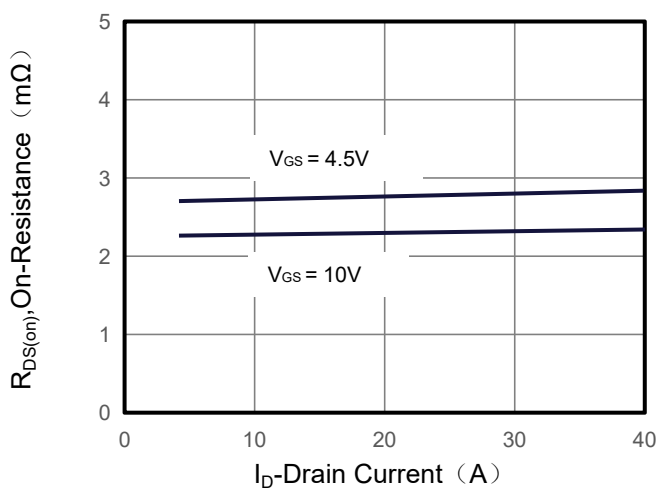


Figure 4. Gate Charge

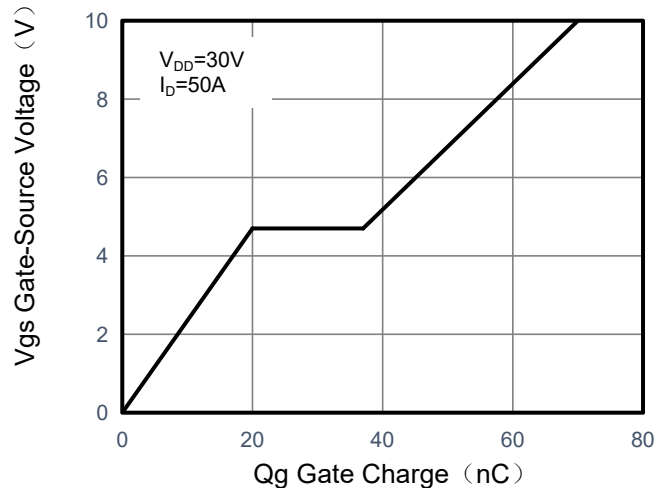


Figure 5. Capacitance

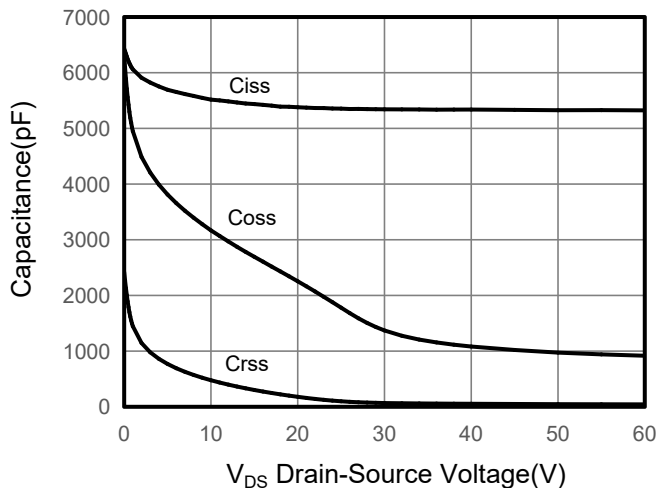
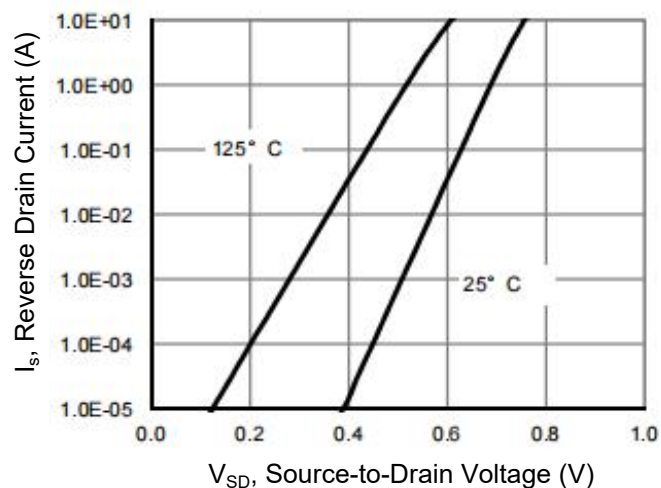


Figure 6. Source-Drain Diode Forward



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

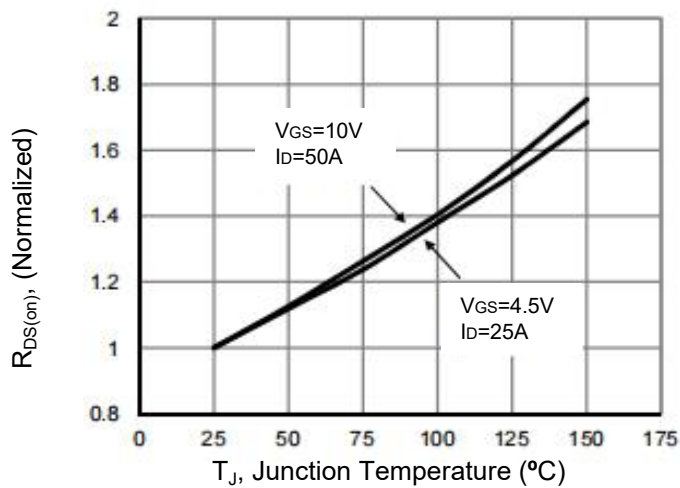


Figure 8. Safe Operation Area

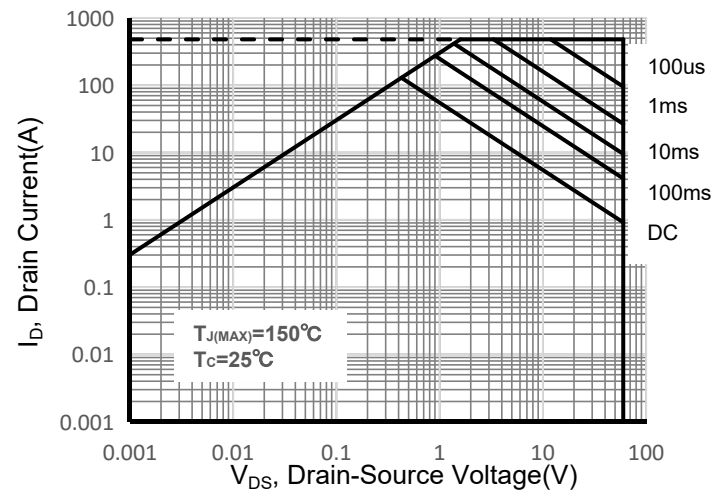


Figure 9. Maximum Continuous Drain Current vs Case Temperature

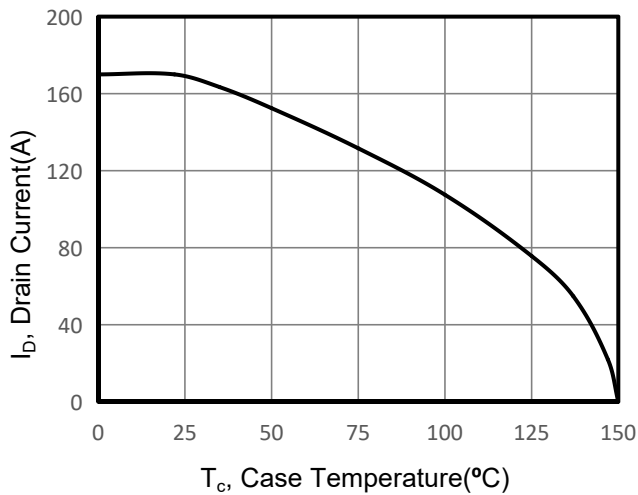
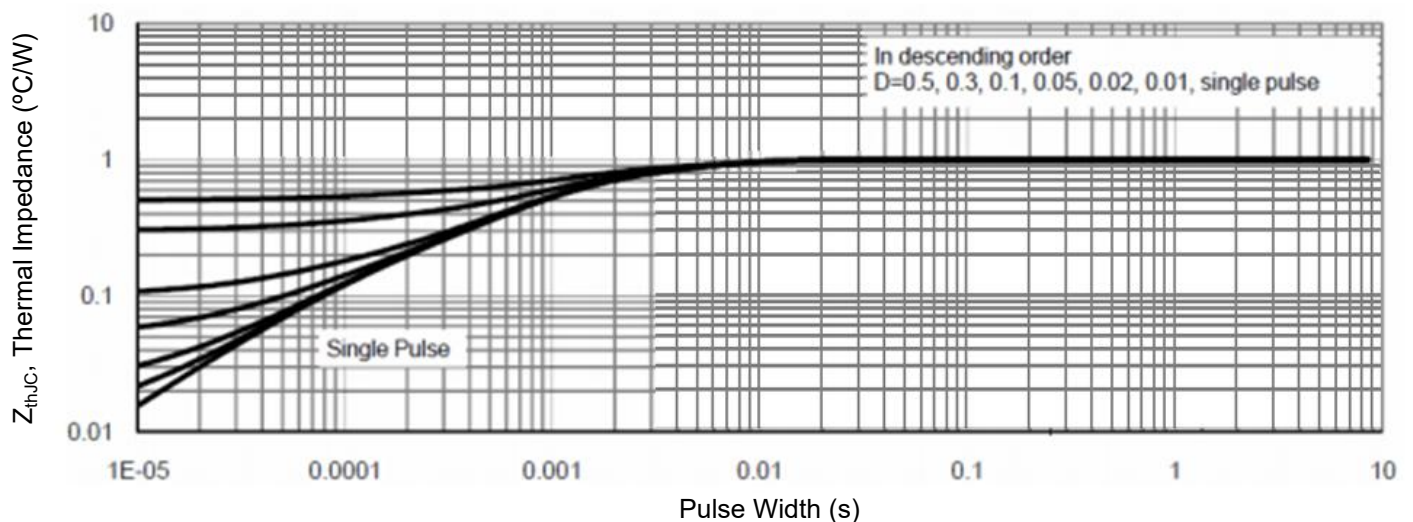
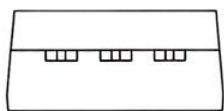
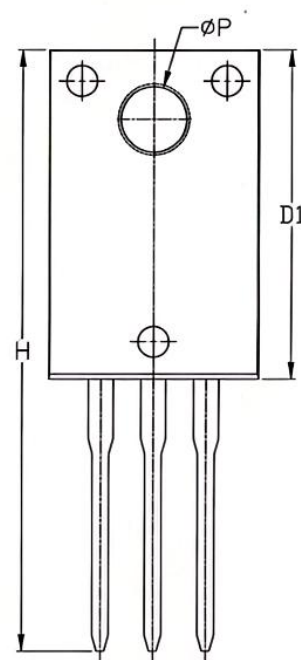
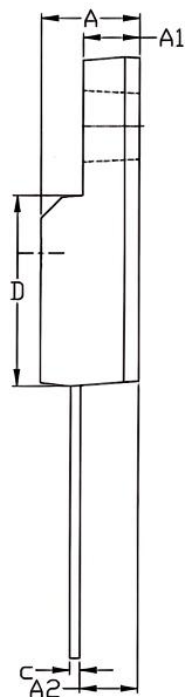
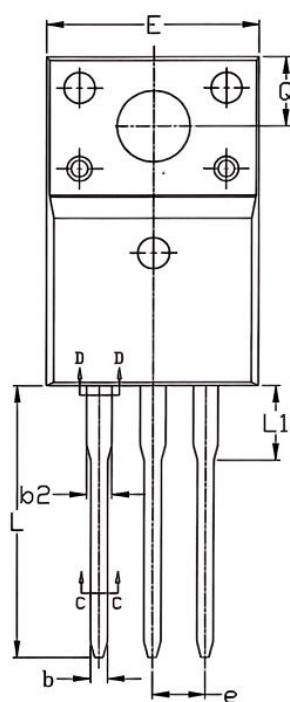


Figure 10. Normalized Maximum Transient Thermal Impedance



TO-220F Package Information



SIDE VIEW(Front)

DIM SYMBOL	MIN.	NOM.	MAX.
A	4.600	4.700	4.800
A1	2.600	2.700	2.800
A2	2.660	2.760	2.860
b	0.740	0.840	0.940
b1	0.700	0.800	0.900
b2	1.140	1.240	1.340
b3	1.100	1.200	1.300
c	0.440	0.540	0.640
c1	0.400	0.500	0.600
D	9.090	9.190	9.290
D1	15.770	15.870	15.970
E	10.060	10.160	10.260
e	2.540 BSC.		
H	28.800	29.000	29.200
L	12.930	13.130	13.330
L1	3.400	3.600	3.800
ØP	3.080	3.180	3.280
Q	3.150	3.350	3.550